

Silicon Carbide Schottky Diode

Features

- 650V Schottky Rectifier
- Zero Reverse Recovery Current
- High-Frequency Operation
- Temperature-Independent Switching Behavior
- Extremely Fast Switching

$$V_{RRM} = 650 \text{ V}$$

$$I_F (T_C=135^\circ\text{C}) = 27 \text{ A}$$

$$Q_C = 90 \text{ nC}$$

Benefits

- Replace Bipolar with Unipolar Rectifiers
- Essentially No Switching Losses
- Higher Efficiency
- Reduction of Heat Sink Requirements
- Parallel Devices Without Thermal Runaway

Package



Applications

- Switch Mode Power Supplies (SMPS)
- Power Factor Correction
- Motor Drives



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Maximum Rated Values ($T_c=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Value	Unit	Test Conditions	Note
V_{RRM}	Repetitive Peak Reverse Voltage	650	V		
V_R	DC Peak Reverse Voltage	650	V		
I_F	Continuous Forward Current	62	A	$T_c=25^\circ\text{C}$	Fig. 3
		27		$T_c=135^\circ\text{C}$	
		20		$T_c=150^\circ\text{C}$	
I_{FRM}	Repetitive Peak Forward Surge Current	104	A	$T_c=25^\circ\text{C}$, $t_p=10$ ms, Half Sine Pulse	
		91		$T_c=110^\circ\text{C}$, $t_p=10$ ms, Half Sine Pulse	
I_{FSM}	Non-Repetitive Forward Surge Current	130	A	$T_c=25^\circ\text{C}$, $t_p=10$ ms, Half Sine Pulse	
		112.9		$T_c=110^\circ\text{C}$, $t_p=10$ ms, Half Sine Pulse	
$I_{F,MAX}$	Non-Repetitive Forward Surge Current	557	A	$T_c=25^\circ\text{C}$, $t_p=10\mu\text{s}$, Square Wave Pulse	
		422		$T_c=110^\circ\text{C}$, $t_p=10\mu\text{s}$, Square Wave Pulse	
P_{tot}	Power Dissipation	192	W	$T_c=25^\circ\text{C}$	Fig. 4
		83		$T_c=110^\circ\text{C}$	
T_J	Operating Temperature	-55 to +175	$^\circ\text{C}$		
T_{stg}	Storage Temperature	-55 to +175	$^\circ\text{C}$		
	TO-220 Mounting Torque	1 8.8	Nm lbf-in	M3 Screw 6-32 Screw	

Electrical Characteristics ($T_J=25^\circ\text{C}$)

Symbol	Parameter	Value			Unit	Test Conditions	Note
		Min.	Typ.	Max.			
V_F	Forward Voltage		1.4	2.0	V	$I_F=20\text{A}$, $T_J=25^\circ\text{C}$	Fig. 1
			1.6	2.2		$I_F=20\text{A}$, $T_J=175^\circ\text{C}$	
I_R	Reverse Current		0.8	100	μA	$V_R=650\text{V}$, $T_J=25^\circ\text{C}$	Fig. 2
			10			$V_R=650\text{V}$, $T_J=175^\circ\text{C}$	
Q_C	Total Capacitive Charge		90		nC	$V_R=650\text{V}$, $T_J=25^\circ\text{C}$	Fig. 5
C	Total Capacitance		1349		pF	$V_R=0\text{V}$, $T_J=25^\circ\text{C}$, $f=1\text{MHz}$	Fig. 6
			110			$V_R=400\text{V}$, $T_J=25^\circ\text{C}$, $f=1\text{MHz}$	
			108			$V_R=650\text{V}$, $T_J=25^\circ\text{C}$, $f=1\text{MHz}$	
E_C	Capacitance Stored Energy		17		μJ	$V_R=650\text{V}$	Fig. 7

Thermal Characteristics

Symbol	Parameter	Value	Unit	Note
$R_{\theta JC}$	Thermal Resistance(Junction to Case)	0.78	$^\circ\text{C/W}$	Fig. 8

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Typical Performance

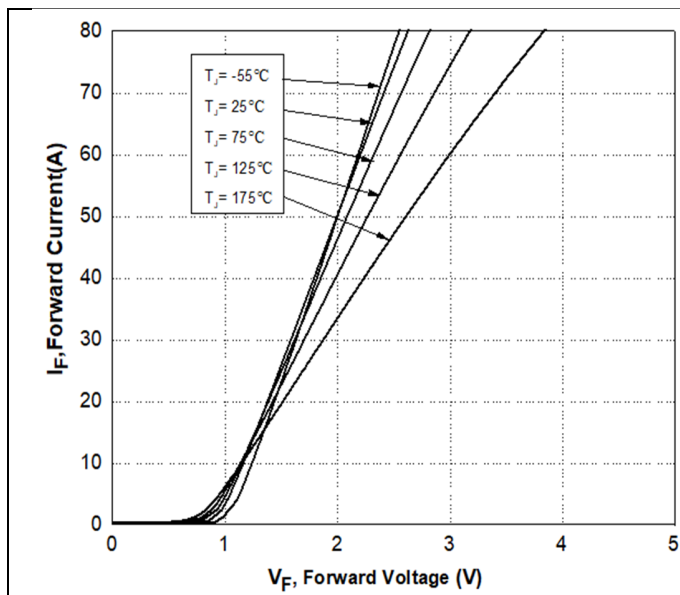


Figure 1. Forward Characteristics

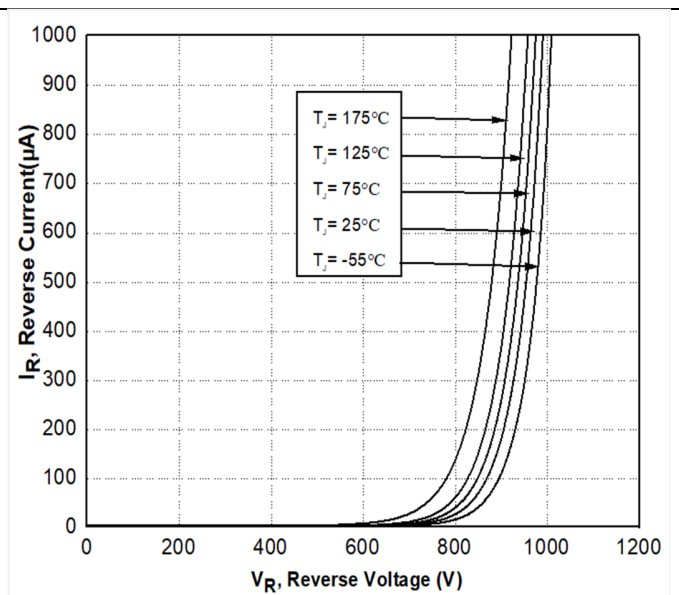


Figure 2. Reverse Characteristics

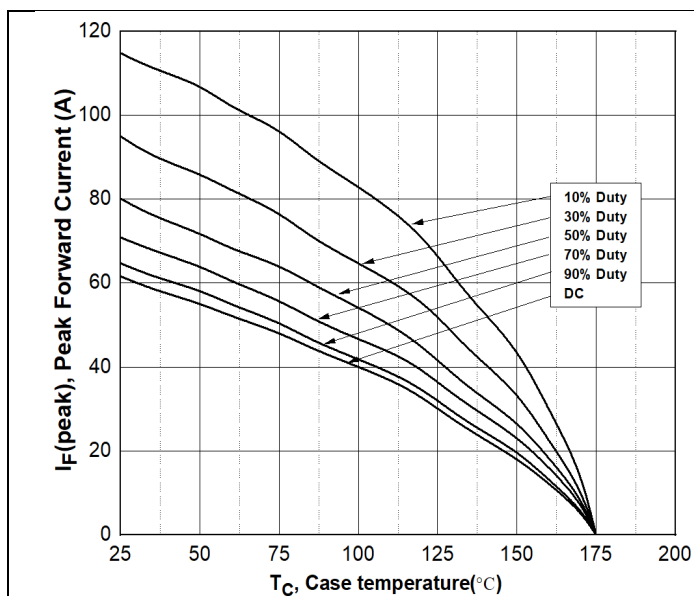


Figure 3. Current Derating

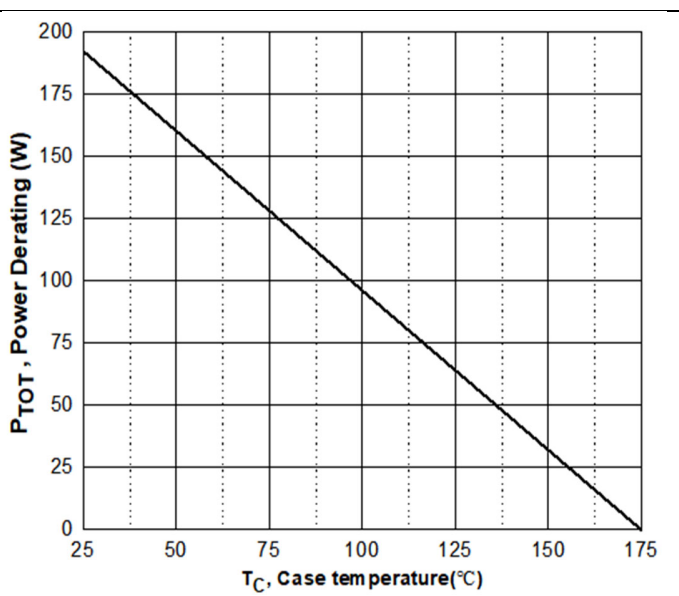


Figure 4. Power Derating

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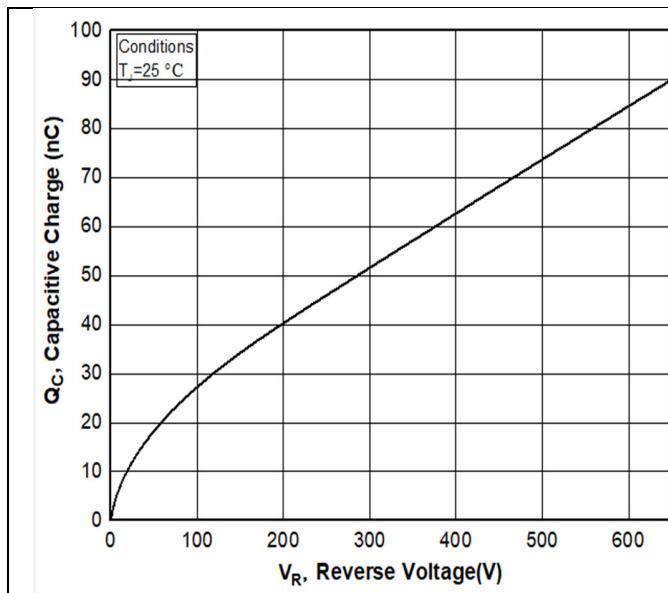


Figure 5. Capacitance Charge Vs. Reverse Voltage

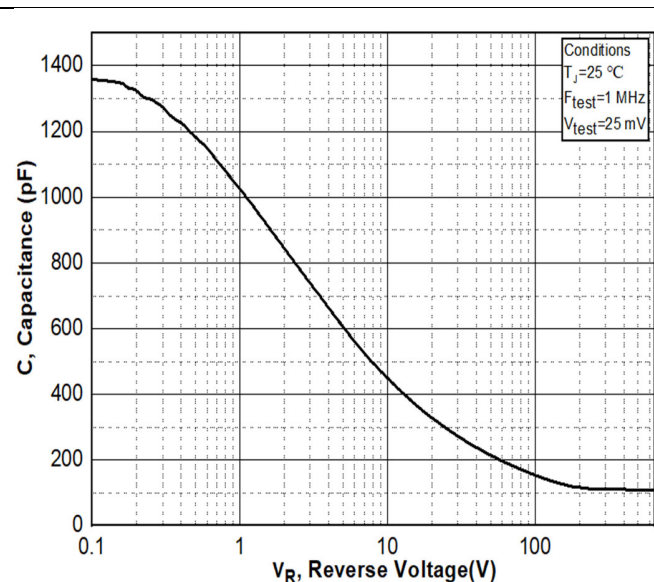


Figure 6. Capacitance Vs. Reverse Voltage

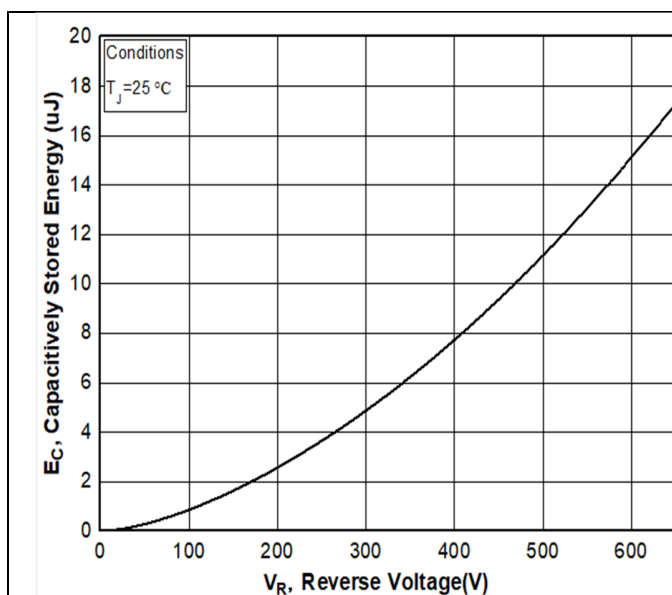


Figure 7. Capacitance Stored Energy

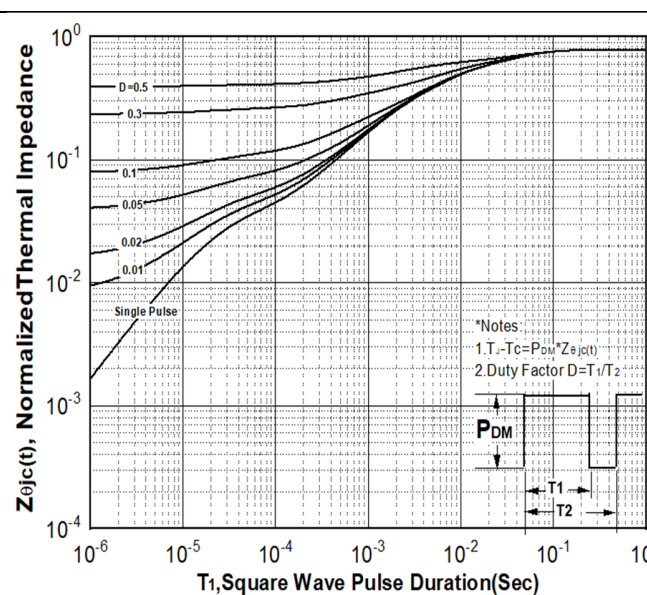


Figure 8. Transient Thermal Response Curve(Junction-to-Case)